EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-----------|--------------|---|--------------------|---------------------|-----------|------------------|
| L1 | . 1 . | ((grinding or polishing or lapping) and wafer and (back or backside)and (air adj pressure adj sensor)).clm. | US-PGPUB; USPAT | OR | ON | 2007/02/02 11:05 |
| L2 | 10 | ((grinding or polishing or lapping) and wafer and (back or backside)and (pressure adj sensor)).clm. | US-PGPUB; USPAT | OR | ON | 2007/02/02 11:07 |
| L3 | 0 | ((grinding or polishing or lapping) and wafer and (dicing or parting) and (back or backside) and (pressure adj sensor)).clm. | US-PGPUB; USPAT | OR | ON | 2007/02/02 11:07 |
| L4 | 170 | ((grinding or polishing or lapping) and wafer and (dicing or parting) and (back or backside)).clm. | US-PGPUB; USPAT | OR | ON | 2007/02/02 11:08 |
| L5 | 9 | ((grinding or polishing or lapping) and wafer and (dicing or parting) and (back or backside)and sensor). clm. | US-PGPUB; USPAT | OR | ON iii | 2007/02/02 11:08 |

2/2/07 11:10:26 AM Page 1